



BSRF test beam updates

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Introduction

- Test beam facility is desirable for detector R&D
- Major TB stations are built out of China
 - Not easy to use due to Covid-19
 - Limited available time slot for CEPC detectors
- Hall 10 test beam was used last year
 - Limited rate
 - Complicate beam setup
 - Can not be used for collision mode
- Potential BSRF test beam facility
 - High energy charged particle observed
 - reasonable rate measured
 - Compatible with BEPC collision mode

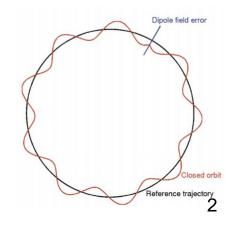
Presented on December 9 (for 4W1B results) https://indico.ihep.ac.cn/event/13391/contribution/3/material/slides/

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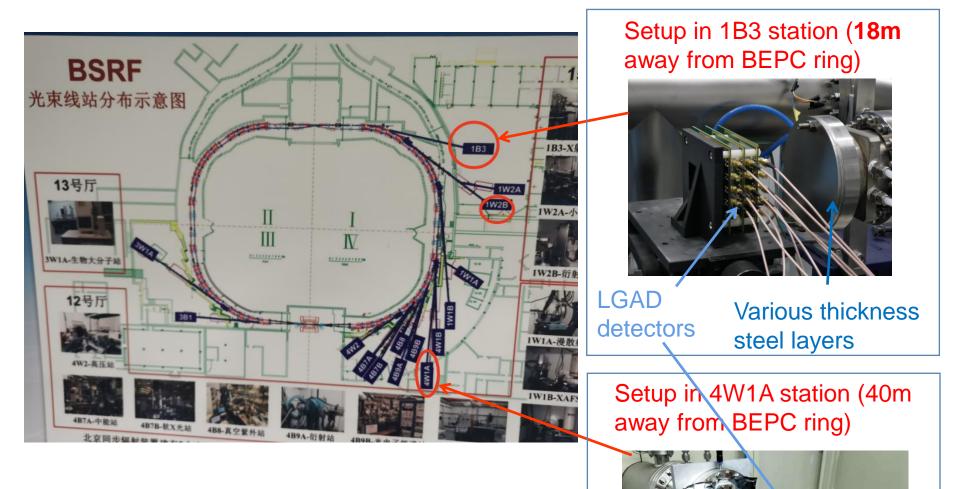
Presented in CEPC day (December)

https://indico.ihep.ac.cn/event/13393/session/2/contribution/9/mater ial/slides/1.pdf



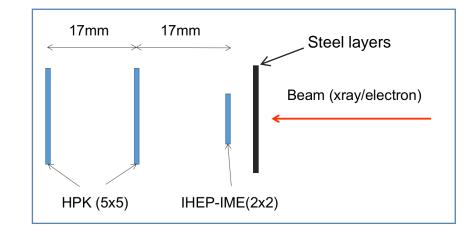


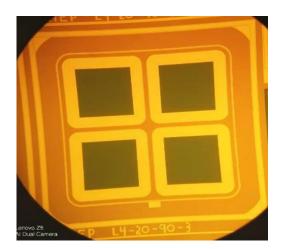
Detection setup

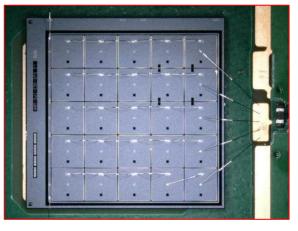


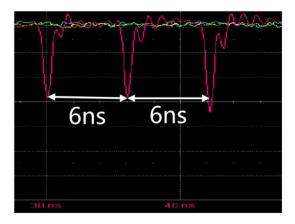
Detectors

- LGAD detector for quick signal test
 - sensive to charged particles
- Three layers LGAD to have coincident test
 - 1xIHEP-IME 2x2 (3x3mm²), time resolution ~30ps
 - 2xHPK 5x5 (6.5mm²), time resolution ~60-70ps









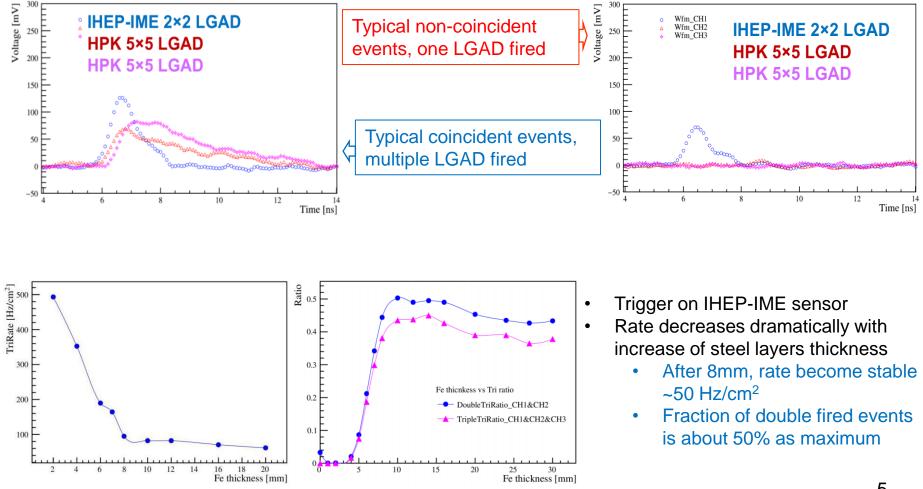
response for x-ray

IHEP-IME 2x2

HPK 5x5

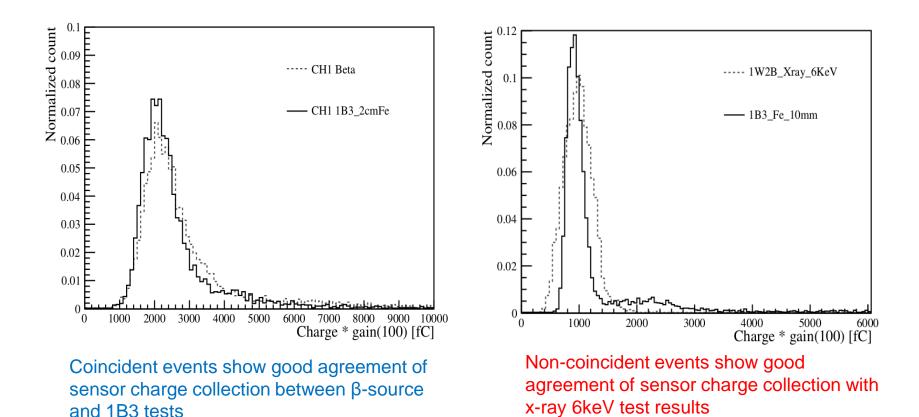
Detection results

- Categorize events according to coincident requirement
 - Non-coincident events: only one LGAD fired, extremely high rate
 - Coincident events: >=2 LGAD observed events
- Measure Coincident rate and fraction with different thickness of steel layer



Compared with β-source test results

- Test LGAD sensor response for 6 KeV x-ray in 1W2B station.
- Compared with to β-source test result in Lab

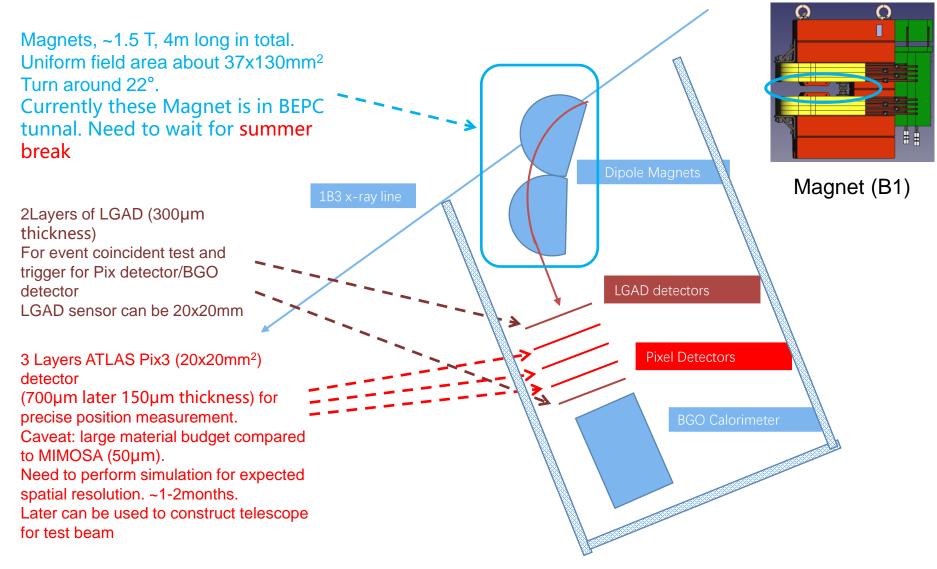


Comparison

	DESY	IHEP Hall 10 E3 Line	BSRF (1B3)
Energy	1-6 GeV	< 1GeV (secondary beam)	~2.5 GeV (depend on BEPC beam energy,TBC)
Particle Type	electrons	Protons/Pions/Electr ons	Electrons (TBC)
Trigger rate	250Hz/cm ² - 4kHz/cm ²	0.6 Hz/cm ² (designed)/<0.1 Hz/cm ² (detected)	~50 Hz/cm ²
Operation time	~10months/Y	~2 month/Y	~10 months/Y
Beam spot	4cm ²	~ 80 cm ²	~12 cm ² (mask size)

- We observed MIP-like particle in BSRF stations, and potentially the electrons
- Reasonable trigger rate ~50/cm², much larger than Hall 10 facility
- The high priority is to confirm the type and energy

1B3 station electron detection proposal



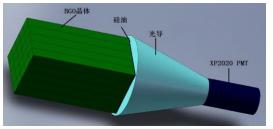
The whole construction and setup will be after summer break (long schedule)

Radiation protection shield

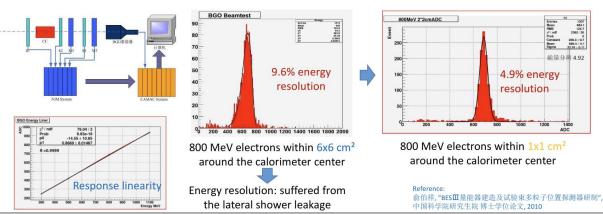
1B3 station electron detection(short schedule)

- Currently 1B3b line is used by accelerator colleague for vacuum ionization study with x-ray about 1-2 months.
 - Stop x-ray, no big impact for high energy particles
- Potentially use BGO calorimeter to test with a setup right after accelerator colleague facility timescale estimated ~1-2months

BGO contains 25 pieces 2x2x20mm³ crystal bars. Total length is about 40-50 cm



- Performance studies: response linearity and energy resolution
 - Combined tests at the IHEP BEPCII-TBF with
 - A Cherenkov Counter (CC), Multi-wire Chambers (M1,M2), Scintillator Counters (S1,S2,S3)





Space for BGO detector, ~80cm Facility for vacuum test

Results in dissertation from Boxiang yu

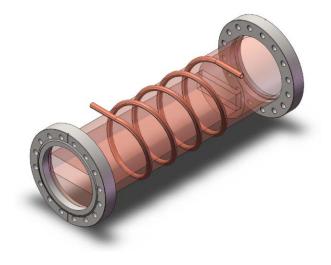
BGO detector is under recalibration with cosmic ray before using for 1B3 station test

Summary

- Test MIP-like particles in BSRF station and its type is suspected to be electrons with relative high energy leaked from BEPC ring
- Brief test with LGAD sensors show a reasonale trigger rate about 50/cm².
- Potentially a test beam facility based on those MIP particles for long term
 - Magnets to separate x-ray and charged particles
 - Pixel detectors used for telescope construction
 - BGO calorimeter to measure energy
- Performing first step to determine the type and energy of such particles
 - Two schedules planned based on BEPC running status

List of facilities

Fixed Mask 62.4x23.4mm²

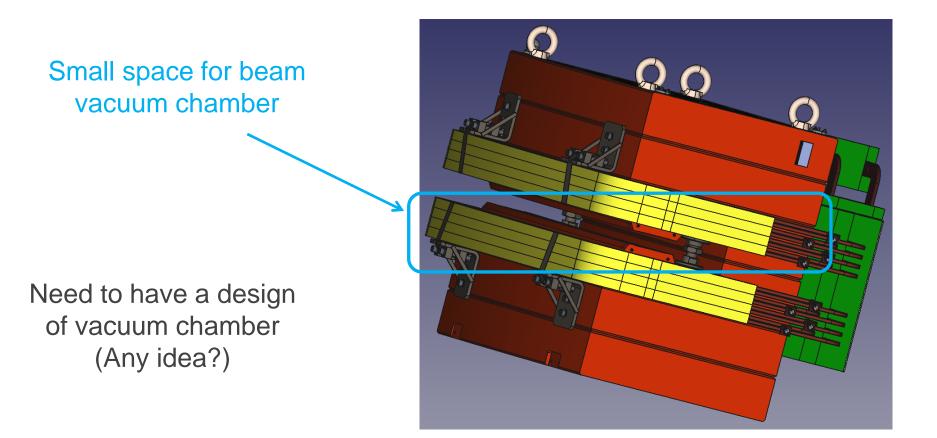


Be window 130x60mm²



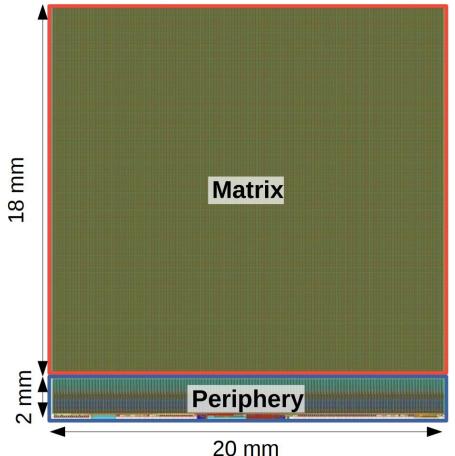
1B3 station electron detection and test beam

3D Model for Magnets



ATLASPix3

- Small material budget
- Pixel size not limited by bump bonds
- Part of the electronics directly inside the pixels (amplifier, comparator)
- Two regions:
 - Pixel matrix (sensitive)
 - Amplifier, comparator, tuning structures
 - Periphery (not sensitive):
 - readout logic, buffers, configuration registers



Need to understand the spatial resolution, material budget etc